



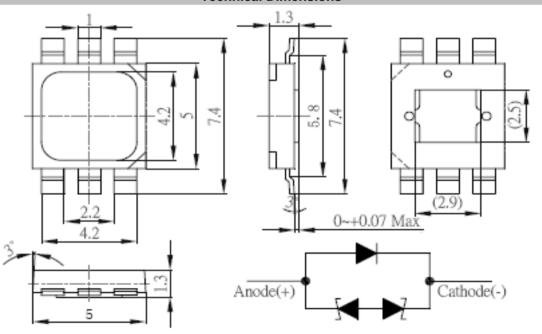
The Power of LED Light

Typical Electrical & Optical Characteristics (IF=350mA and Ta=25°C)

Part-No.	_	inant igth (nm) CT(K)	Forward Voltage (V)		Luminious Flux (lm)		Rever- se Cur- rent (µA)	50% Power Angle
	Min	Тур	Min	Max	Min	Тур	max	Тур
M11E8001	6000	7000	3.3	4.0	75	85	10	120

- 1. Tolerance of measurement of luminous flux: +/-15%
- 2. Tolerance of measurement of dominant Wavelength: +/-1nm
- 3. Tolerance of measurement of CCT (Correlated color temperature +/- 200K
- 4. Tolerance of measurement of forward voltage +/-0,1V

Technical Dimensions









Features

Highest Luminous Flex Long Lifetime Operation Super Energy Efficency Superior UV Resistance Superior ESD protection

Absulut Maximum Ratings (Ta=25°C)

Items	Symb ols	Absulut maximum Rating Cool White	Unit
Power Dissipation	Pd	1600	mW
Forward Current	lf	400	mA
Peak Forward Current	Ifp	500	mA
Reverse Voltage	Vr	5	V
LED Junction Temperature	Tj		°C
Operating Temperature	Topr	-30°C ~ +85°C	°C
Storage Temperature	Tstg	-40°C ~ +100°C	°C

^{*} Pulse width ≤ 0,1msec duty ≤ 1/10

Tops Power LED

Part No.: M11E8001

Customer:

DATE

MATL: DRW: CHKD Wilson Wilson Mason 12.07.2010 Jason **TOLERANCE** APPD: Schumi FINISH Sheet No. 1 from 10 Jamy













BIN GUIDE / HIGH POWER

Tolerance of measurement of luminous Flux is +/- 15%

Code	Luminous I	Flux Range	Code	Luminous Flux Range			
Code	min	max.	Code	min	max.		
Α	1	2	P2	70	80		
В	2	2,5	M1	80	90		
С	2,5	3,2	M2	90	100		
D	3,2	4	N1	100	110		
Е	4	5	N2	110	120		
F	5	6,2	P1	120	130		
G	6,2	7,7	P2	130	140		
Н	7,7	9,6	Q1	140	150		
J	9,6	12	Q2	150	160		
K	12	15	R1	160	170		
L1	15	19	R2	170	180		
L2	19	24	S1	180	200		
M1	24	30	S2	200	220		
M2	30	40	T1	220	240		
N1	40	50	T2	240	260		
N2	50	60	U1	250	280		
P1	60	70					
			1	C/F	Г		

iii om Lit						
Code	CCT F	Range	Code	CCT Range		
Code	Min	Max	Code	Min	Max	
Α	2700	2900	М	4900	5100	
В	2900	3100	N	5100	5500	
С	3100	3300	Р	5500	6000	
D	3300	3500	Q	6000	6500	
E	3500	3700	R	6500	7000	
F	3700	3900	S	7000	7500	
G	3900	4100	Т	7500	8000	
Н	4100	4300	U	8000	9000	
J	4300	4500	V	9000	10000	
K	4500	4700	W	10000	12000	
L	4700	4900				
Tolerance of mea	surement of CCT i	is +/-100K.	_	_	_	

Г			,0	,	U												_
				В		Н	G	i/E		F	,	Y	Q	/P	R	/U	
(Color	Code	Min	max	Min	max	Min	max	Min	max	Min	max	Min	max	Min	max	of
	D	0	450	455	490	495	515	520	560	565	580	583	600	605	620	625	measurement elength is +/-1
	D.	1	455	460	495	500	520	525	565	570	583	586	605	610	625	630	ren is
	D:	2	460	465	500	505	525	530	570	575	586	589	610	615	630	635	e of measul
	D:	3	465	470	505	510	530	535	575	580	589	592	615	620	635	640	me
	D ₄	4	470	475	510	515	535	540			592	595			640	645	of of
	D:	5	475	480			540	545			595	598			645	650	
	D	6	480	485			545	550							650	655	Tolerand
	D.	7	485	490			550	555							655	660	L of
	D	8					555	560							660	665	
	DR	W:	Ja	son	CH	IKD	Wil	son	MA	NTL:	Wil	son	TOLE	RANCE	Ma	son	
	APF	PD:	Sch	numi					FIN	IISH	Ja	my				Shee	et No.

DATE

Tops Power LED

12.07.2010

2 from 10

Part No.: M11E8001

Customer:

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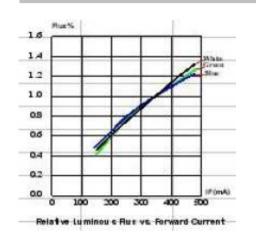


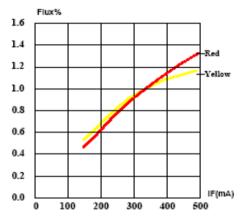




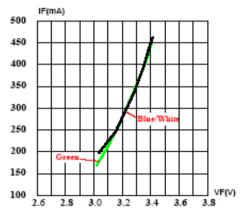
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Typical Electrical / Optical Characteristics Curves (Ta=25°C Unless otherwise noted)





Relative Luminous Flux vs. Forward Current



Forward Current vs. Forward Voltage

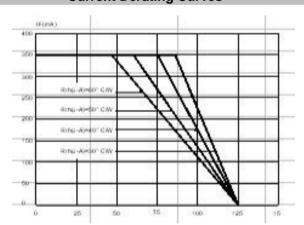
500	IF(mA)				_	_			_	_		
450									4	_			
400									Z				
350	L							/					
300	L						/						
250	H			Red	7	y							
200				7	14	Ye	llov	,					
150	\vdash			_						\vdash	Н		
100 1	.8	2	.0	2	.2	2	.4	2	.6	2	.8	3	VF(V) .0
Forward Current vs. Forward Voltage													

Forward Vo	oltage Rank	
Min.	Max.	
1,6	1,8	
1,8	2,0	
2,0	2,2	
2,2	2,4	
2,4	2,6	
2,6	2,8	
2,8	3,0	
3,0	3,2	

Tolerance of measurement of forward voltage is +/-0,1V

Code	Forward Voltage Rank					
Code	Min.	Max.				
J	3,20	3,40				
K	3,40	3,60				
L	3,60	3,80				
М	3,80	4,00				
N	4,00	4,20				
Р	4,20	4,40				
Q	4,40	4,60				
R	4,60	4,80				

Current	Derating	Curvae
Current	Deraumu	Curves



Tops Power LED

Part No.: M11E8001

-Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010
APPD:	Schumi			FINISH	Jamv		Shee	t No.	3 from 10

Code

Α В

С D Ε

G





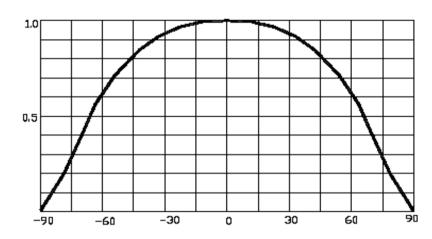
The Power of LED Light





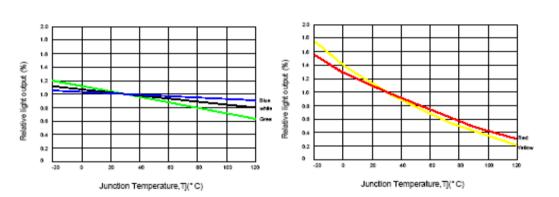


Typical Representative Spatial Radiation Paddern of single LED

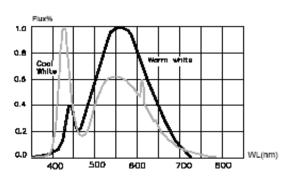


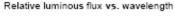
Angular Displacement(degress)

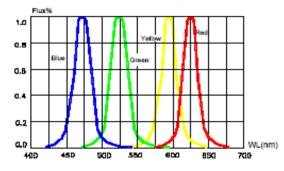
Light Output Characteristics



Wavelength Characteristics







Relative luminous flux vs. wavelength

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Tops P	ower LED
Part No.:	M11E8001

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DRW: CHKD Wilson MATL: Wilson TOLERANCE Mason 12.07. Jason DATE APPD: Schumi **FINISH** Sheet No. 4 from 10 Jamy









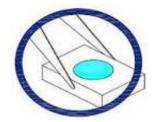


Handling Informations

- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

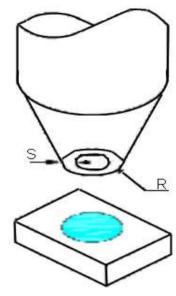
1. Handle the component along the side surfaces by using forceps or appropriate tools







2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratsch the silicone lens or damage the internal circuitry.



Τo	ns	Power	LED
	PS		

Part No.: **M11E8001**

Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010
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Moisture Proof Packing

In Order to prevent moisture absorption into DIAMOND = TOP LED / XEON POWER during the transportation and storage. DIAMOND TOP-LED / XEON-POWER LED is packed in a moisture barrier bag. Desiccants and humidity indicator are packed together with DIAMOND TOP-LED / XEON-POWER LED as the secondary protection. The indication of humidity card provides the information of humidity within TOP Packing.

Storage

Shelf life in original sealed bag in storage condition of <40°C and 90% RH is 12 mounths. Baking is required whenever shelf life is expired. Before opening the packaging please check wether bag leak air or not. After opening the DIAMOND TOP-LED / XEON POWER LED must be storad under the condition <30°C and 60% RH. Under this condition DIAMOND TOP-LED / XEON POWER LED must be used (subject to reflow) within 24-hours after bag opening, and re-baking is required when exceeding 24 hours. For baking, place DIAMOND TOP-LED / XEON POWER LED in oven at temperature 75°C +/-5°C and relative humidity <10%RH, for 24 hours. Take out the material from packaging bag for re-bake. Do not open the door of oven frequently during the baking process.

Manual soldering (We do not recommend this method strongly).

No mechanical stress should be exerted on the resin portion of DIAMOND TOP-LED / XEON POWER during soldering.

Handling of DIAMOND TOP-LED / XEON POWER LED should be done when the package has been cooled down to below 40°C or less. This is to prevent the DIAMOND TOP-LED / XEON POWER failures due the thermal-mechanical strss during handling.

Reflow soldering should not be done more than one time.

No stress should be exerted on the package during soldering.

Electrostatic Discharge and Surge current.

Electrostatic discharge (ESD) or surge current (EOS) may damage LED.

Precautions such as ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling DIAMOND TOP-LED / XEON POWER LED.

All devices, equipment and machinery must be prpertly grounded.

It is recommended to perform electrical test to screen out ESD failures in final inspection.

It is important to eliminate the possibility of surge current during circuity design.

Heat Management

Heat manegement of DIAMOND TOP-LED / XEON POWER must be taken into into consideration during the design stage of DIAMOND TOP-LED / XEON POWER LED application. The current should be de-rated appropriately by refering to the de-rating curve attached on each product specification.

Part No.: M11E8001 Wilson DRW: CHKD MATL: Wilson **TOLERANCE** Mason 12.07.2010 Jason DATE Customer: APPD: Schumi **FINISH** Sheet No. 6 from 10 Jamy

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Tops Power LED



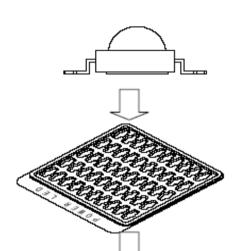




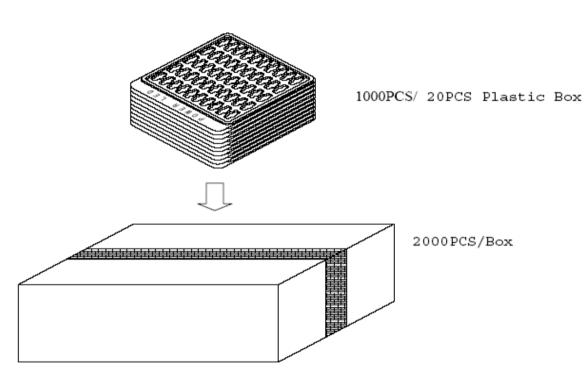




Packing Specifications



50PCS/ Plastic Box



DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010	\int_{C}
APPD:	Schumi			FINISH	Jamy		Shee	t No.	7 from 10	ľ

Tops Power LED

Part No.: M11E8001

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Ordering Informations

Serie	Color Code	ROHS	Packing				
					_		
M11E8001	CW	R	TR				

CW	R = ROHS	TR= TAPE
=	Conform	REEL
Cool White	N= NON	BU = Bulk-
	ROHS	Ware

Tops Power LED

Part No.: **M11E8001**

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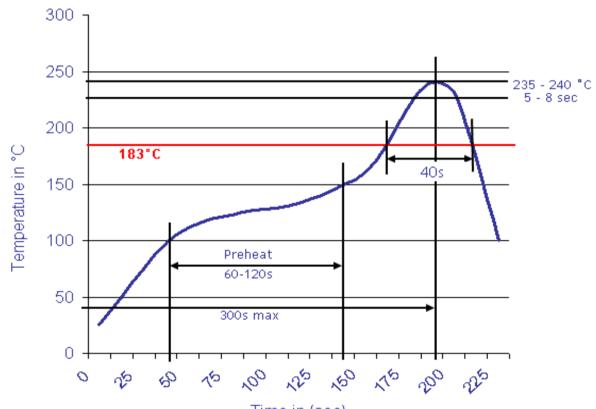






Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



Time in (sec)

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Tops Power LED

Part No.: **M11E8001**

Customer:



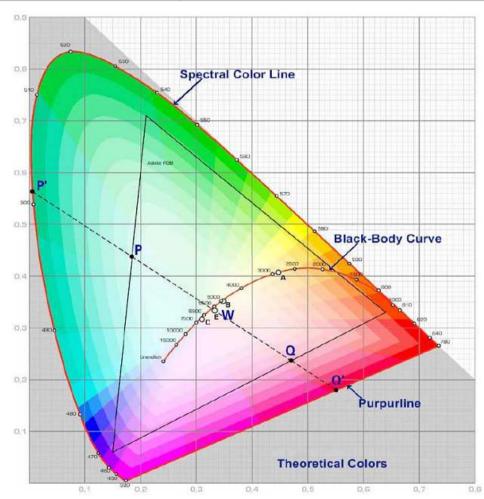








Spectral Color Curve



Tops Power LED					
Part No.:	M11E8001				
Customer:					

CHKD MATL: DRW: Wilson 12.07.2010 Jason Wilson TOLERANCE Mason DATE APPD: FINISH 10 from 10 Schumi Sheet No. Jamy

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